

Im392-N Low Power Operational Amplifier/Voltage Comparator

Check for Samples: LM392-N

FEATURES

- Wide Power Supply Voltage Range
 - Single Supply: 3V to 32V
 - Dual Supply: ±1.5V to ±16V
- Low Supply Current Drain—Essentially Independent of Supply Voltage: 600 μA
- Low Input Biasing Current: 50 nA
- Low Input Offset Voltage: 2 mV
- Low Input Offset Current: 5 nA
- Input Common-Mode Voltage Range Includes Ground
- Differential Input Voltage Range Equal to the Power Supply Voltage
- ADDITIONAL OP AMP FEATURES
 - Internally Frequency Compensated for Unity Gain
 - Large DC Voltage Gain: 100 dB
 - Wide Bandwidth (Unity Gain): 1 MHz
 - Large Output Voltage Swing: 0V to V⁺ -1.5V
- ADDITIONAL COMPARATOR FEATURES
 - Low Output Saturation Voltage: 250 mV at 4 mA
 - Output Voltage Compatible with all Types of Logic Systems

ADVANTAGES

- Eliminates Need for Dual Power Supplies
- An Internally Compensated Op Amp and a Precision Comparator in the Same Package
- Allows Sensing at or Near Ground
- Power Drain Suitable for Battery Operation
- Pin-Out is the Same as Both the LM358 Dual Op Amp and the LM393 Dual Comparator

DESCRIPTION

The Im392-N series consists of 2 independent building block circuits. One is a high gain, internally frequency compensated operational amplifier, and the other is a precision voltage comparator. Both the operational amplifier and the voltage comparator have been specifically designed to operate from a single power supply over a wide range of voltages. Both circuits have input stages which will common-mode input down to ground when operating from a single power supply. Operation from split power supplies is also possible and the low power supply current is independent of the magnitude of the supply voltage.

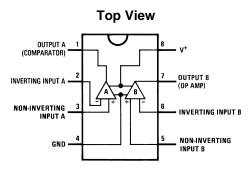
Application areas include transducer amplifier with pulse shaper, DC gain block with level detector, VCO, as well as all conventional operational amplifier or voltage comparator circuits. Both circuits can be operated directly from the standard 5 V_{DC} power supply voltage used in digital systems, and the output of the comparator will interface directly with either TTL or CMOS logic. In addition, the low power drain makes the Im392-N extremely useful in the design of portable equipment.

ATA .

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Connection Diagram



(Amplifier A = Comparator) (Amplifier B = Operational Amplifier)

Figure 1. SOIC and PDIP Packages See Package Numbers D0008A and P0008E



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Submit Documentation Feedback



Absolute Maximum Ratings (1)(2)

	lm392-N
Supply Voltage, V ⁺	32V or ±16V
Differential Input Voltage	32V
Input Voltage	-0.3V to +32V
Power Dissipation (3)	
Molded DIP (LM392N)	820 mW
Small Outline Package (LM392M)	530 mW
Output Short-Circuit to Ground (4)	Continuous
Input Current ($V_{IN} < -0.3 V_{DC}$) (5)	50 mA
Operating Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C
Lead Temperature (Soldering, 10 seconds)	260°C
ESD rating to be determined.	•
Soldering Information	
Dual-in-Line Package	
Soldering (10 seconds)	260°C
Small Outline Package	
Vapor Phase (60 seconds)	215°C
Infrared (15 seconds)	220°C

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) For operating at temperatures above 25°C, the lm392-N must be derated based on a 125°C maximum junction temperature and a thermal resistance of 122°C/W which applies for the device soldered in a printed circuit board, operating in still air ambient. The dissipation is the total of both amplifiers—use external resistors, where possible, to allow the amplifier to saturate or to reduce the power which is dissipated in the integrated circuit.
- (4) Short circuits from the output to V⁺ can cause excessive heating and eventual destruction. When considering short circuits to ground, the maximum output current is approximately 40 mA for the op amp and 30 mA for the comparator independent of the magnitude of V⁺. At values of supply voltage in excess of 15V, continuous short circuits can exceed the power dissipation ratings and cause eventual destruction.
- (5) This input current will only exist when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistors becoming forward biased and thereby acting as input diode clamps. In addition to this diode action, there is also lateral NPN parasitic transistor action on the IC chip. This transistor action can cause the output voltages of the amplifiers to go to the V⁺ voltage level (or to ground for a large overdrive) for the time duration that an input is driven negative. This is not destructive and normal output states will re-establish when the input voltage, which was negative, again returns to a value greater than -0.3V (at 25°C).

Electrical Characteristics

 $(V^+ = 5 V_{DC}; specifications apply to both amplifiers unless otherwise stated) (1)$

Parameter	Conditions		lm392-N				
Farameter	Conditions	Min	Тур	Max	Units		
Input Offset Voltage	$T_A = 25^{\circ}C, (2)$		±2	±5	mV		
Input Bias Current	IN(+) or IN(-), $T_A = 25$ °C, $^{(3)}$, $V_{CM} = 0$ V		50	250	nA		
Input Offset Current	IN(+) - IN(-), T _A = 25°C		±5	±50	nA		
Input Common-Mode Voltage Range	$V^{+} = 30 V_{DC}, T_{A} = 25^{\circ}C, (4)$	0		V ⁺ −1.5	٧		
Supply Current	$R_L = \infty$, $V^+=30 \text{ V}$		1	2	mA		
Supply Current	$R_L = \infty$, $V^+ = 5 V$		0.5	1	mA		

- (1) These specifications apply for $V^+ = 5V$, unless otherwise stated. For the Im392-N, temperature specifications are limited to $0^{\circ}C \le T_A \le +70^{\circ}C$.
- (2) At output switch point, V_O ≈ 1.4V, R_S = 0Ω with V⁺ from 5V to 30V; and over the full input common-mode range (0V to V⁺ − 1.5V).
- (3) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.
- (4) The input common-mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3V. The upper end of the common-mode voltage range is V⁺ − 1.5V, but either or both inputs can go to 32V without damage.

Product Folder Links: LM392-N



Electrical Characteristics (continued)

 $(V^+ = 5 V_{DC}; specifications apply to both amplifiers unless otherwise stated)$ (1)

Danamatan	Conditions		1114		
Parameter	Conditions	Min	Тур	Max	Units
Amplifier-to-Amplifier Coupling	f = 1 kHz to 20 kHz, T _A = 25°C, Input Referred, ⁽⁵⁾		-100		dB
Input Offset Voltage	(2)			±7	mV
Input Bias Current	IN(+) or IN(-)			400	nA
Input Offset Current	IN(+) - IN(-)			150	nA
Input Common-Mode Voltage Range	$V^{+} = 30 V_{DC}, $ ⁽⁴⁾	0		V+-2	V
Differential Input Voltage	Keep All V _{IN} ' ^s ≥ 0 V _{DC} (or V ⁻ , if used) ⁽⁶⁾			32	V
OP AMP ONLY		1			
Large Signal Voltage Gain	$V^+ = 15 V_{DC}$, V_o swing = 1 V_{DC} to 11 V_{DC} , $R_L = 2 k\Omega$, $T_A = 25^{\circ}C$	25	100		V/mV
Output Voltage Swing	$R_L = 2 \text{ k}\Omega$, $T_A = 25^{\circ}\text{C}$	0		V ⁺ −1.5	V
Common-Mode Rejection Ratio	DC, $T_A = 25^{\circ}C$, $V_{CM} = 0$, V_{DC} to $V^+ - 1.5 V_{DC}$	65	70		dB
Power Supply Rejection Ratio	DC, T _A = 25°C	65	100		dB
Output Current Source	$V_{IN(+)} = 1 V_{DC}, V_{IN(-)} = 0 V_{DC}, V^{+} = 15 V_{DC}, V_{o} = 2 V_{DC}, T_{A} = 25^{\circ}C$	20	40		mA
Output Current Sink	$V_{IN(-)} = 1 V_{DC}, V_{IN(+)} = 0 V_{DC}, V^{+} = 15 V_{DC}, V_{o} = 2V_{DC}, T_{A} = 25^{\circ}C$	10	20		mA
	$V_{IN(-)} = 1 V_{DC}, V_{IN(+)} = 0 V_{DC}, V^{+} = 15 V_{DC}, V_{o} = 200 \text{ mV}, T_{A} = 25^{\circ}\text{C}$	12	50		μA
Input Offset Voltage Drift	$R_S = 0\Omega$		7		μV/°C
Input Offset Current Drift	$R_S = 0\Omega$		10		pA _{DC} /°C
COMPARATOR ONLY		1			
Voltage Gain	$R_L \ge 15 \text{ k}\Omega, V^+ = 15 \text{ V}_{DC}, T_A = 25^{\circ}\text{C}$	50	200		V/mV
Large Signal Response Time ⁽⁷⁾	V_{IN} = TTL Logic Swing, V_{REF} = 1.4 V_{DC} V_{RL} = 5 V_{DC} , R_L = 5.1 k Ω , T_A = 25°C		300		ns
Response Time	$V_{RL} = 5 V_{DC}, R_L = 5.1 k\Omega, T_A = 25 ^{\circ}C$		1.3		μs
Output Sink Current	$V_{IN(-)} = 1 \ V_{DC}, \ V_{IN(+)} = 0 \ V_{DC}, \ V_{O} \ge 1.5 \ V_{DC}, \ T_{A} = 25^{\circ}C$	6	16		mA
Saturation Voltage	$V_{IN(-)} \ge 1 \ V_{DC}, \ V_{IN(+)} = 0, \ I_{SINK} \le 4 \ mA, \ T_A = 25^{\circ}C$		250	400	mV
	$V_{IN(-)} \ge 1 \ V_{DC}, \ V_{IN(+)} = 0,$ $I_{SINK} \le 4 \ mA$			700	mV
Output Leakage Current	$V_{IN(-)} = 0$, $V_{IN(+)} \ge 1$ V_{DC} , $V_{o} = 5$ V_{DC} , $T_{A} = 25$ °C		0.1		nA
	$V_{IN(-)} = 0, V_{IN(+)} \ge 1 V_{DC},$ $V_{o} = 30 V_{DC}$			1.0	μΑ

⁽⁵⁾ Due to proximity of external components, insure that coupling is not originating via the stray capacitance between these external parts. This typically can be detected as this type of capacitive coupling increases at higher frequencies.

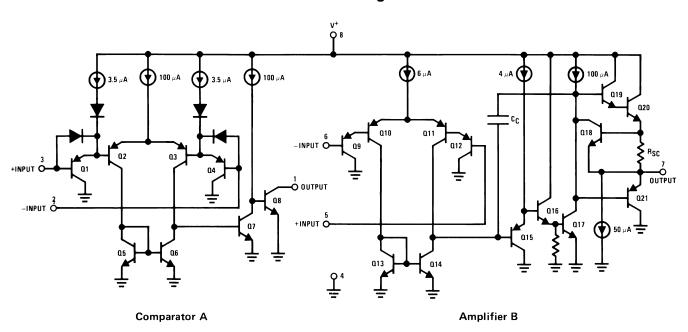
(7) The response time specified is for a 100 mV input step with 5 mV overdrive. For larger overdrive signals 300 ns can be obtained.

Submit Documentation Feedback

⁽⁶⁾ Positive excursions of input voltage may exceed the power supply level. As long as the other input voltage remains within the common-mode range, the comparator will provide a proper output state. The input voltage to the op amp should not exceed the power supply level. The input voltage state must not be less than −0.3V (or 0.3V below the magnitude of the negative power supply, if used) on either amplifier.



Schematic Diagram





APPLICATION HINTS

Please refer to the application hints section of the LM193 and the LM158 datasheets.

Submit Documentation Feedback

Copyright © 1998–2013, Texas Instruments Incorporated



REVISION HISTORY

Changes from Revision C (March 2013) to Revision D							
•	Changed layout of National Data Sheet to TI format	(

Product Folder Links: LM392-N





6-Jul-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM392M	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	0 to 70	LM392 M	Samples
LM392M/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	0 to 70	LM392 M	Samples
LM392MX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	0 to 70	LM392 M	Samples
LM392N/NOPB	ACTIVE	PDIP	Р	8	40	Green (RoHS & no Sb/Br)	Call TI SN	Level-1-NA-UNLIM	0 to 70	LM 392N	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and



PACKAGE OPTION ADDENDUM

6-Jul-2020

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 25-Sep-2019

TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM392MX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

www.ti.com 25-Sep-2019



*All dimensions are nominal

ĺ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	LM392MX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

Tl's products are provided subject to Tl's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such Tl products. Tl's provision of these resources does not expand or otherwise alter Tl's applicable warranties or warranty disclaimers for Tl products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2020, Texas Instruments Incorporated